



Parameter	Rating	Units		
Blocking Voltage	350	V _P		
Load Current	120	mA		
Max On-resistance	30	Ω		

Features

- Small 4-Pin SOP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- · No Moving Parts
- High Reliability
- · Arc-Free With No Snubbing Circuits
- 1500V_{rms} Input/Output Isolation
- No EMI/RFI Generation
- · Machine Insertable, Wave Solderable
- Tape & Reel Version Available

Applications

- Telecommunications
 - Telecom Switching
 - · Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hook Switch
 - Dial Pulsing
 - · Ground Start
 - Ringing Injection
- Instrumentation
 - Multiplexers
 - · Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - · Meters (Watt-Hour, Water, Gas)
- · Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The CPC1130N is a miniature 1-Form-B solid state relay which uses optically coupled MOSFET technology to provide 1500V_{rms} of input to output isolation. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS® architecture. The optically coupled input is controlled by a highly efficient GaAIAs infrared LED. The CPC1130N offers board space savings of at least 20% versus competitive 4-Pin SOP solid state relay.

Approvals

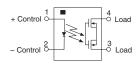
- UL Recognized Component: File #E76270
- Certified to EN60950

Ordering Information

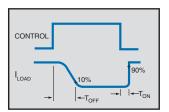
Part #	Description
CPC1130N	4-Pin SOP (100/tube)
CPC1130NTR	4-Pin SOP (2000/reel)

Pin Configuration

CPC1130N Pinout



Switching Characteristics of Normally Closed (Form B) Devices











Absolute Maximum Ratings (@ 25°C)

Parameter	Ratings	Units	
Blocking Voltage	350	V_P	
Reverse Input Voltage	5	V	
Input Control Current	50	mA	
Peak (10ms)	1	Α	
Input Power Dissipation	150	mW	
Total Power Dissipation ¹	400	mW	
Capacitance Input to Output	1	pF	
Isolation Voltage Input to Output	1500	V _{rms}	
Operational Temperature	-40 to +85	°C	
Storage Temperature	-40 to +125	°C	

¹ Derate Linearly 3.33 mw / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

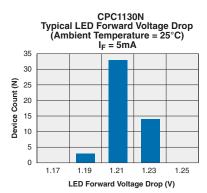
Electrical Characteristics

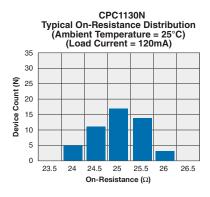
Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics @ 25°C	,					
Load Current						
Continuous ¹	-	I _L	-	-	120	
Peak	t =10ms	I _{LPK}	-	-	350	– mA
On-Resistance ²	I _L =120mA	R _{on}	-	25	30	Ω
Off-State Leakage Current	V _L =350V, I _F =2mA	I _{LEAK}	-	-	5	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	T _{ON}	-	-	2	ma
Turn-Off		T _{OFF}	-	-	2	– ms
Output Capacitance	50V; f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics @ 25°C						
Input Control Current ³	I _L =120mA	I _F	-	-	2	mA
Input Dropout Current	-	I _F	0.3	0.9	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA

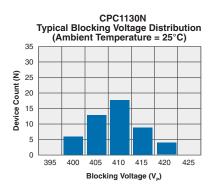
Load current derates linearly from 120mA @ 25°C to 80mA @ 85°C.
Measurement taken within 1 second of on time.
For applications requiring high temperature operation (greater than 60°C) an LED drive current of 5mA is recomended.

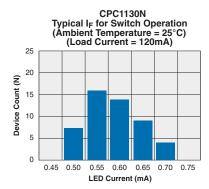


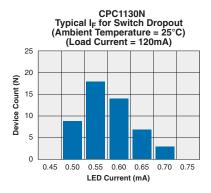
PERFORMANCE DATA*

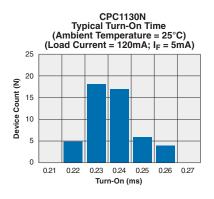


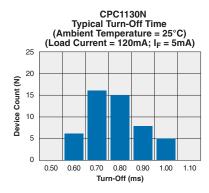


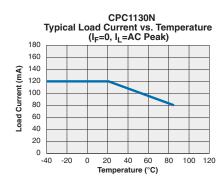


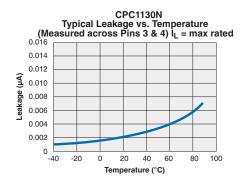


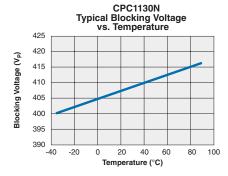


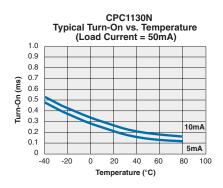


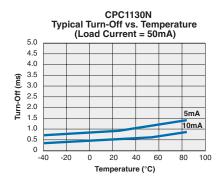








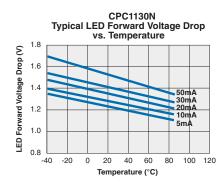


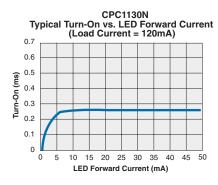


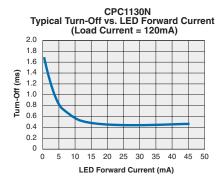
^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

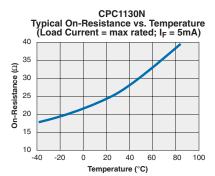


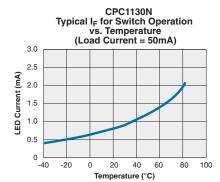
PERFORMANCE DATA*

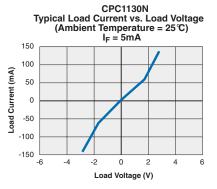


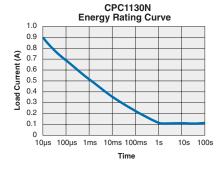












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MANUFACTURING INFORMATION

Moisture Sensitivity

Clare has characterized the moisture reflow sensitivity of this package, and has determined that this component must be handled in accordance with IPC/JEDEC standard J-STD-033 moisture sensitivity level (MSL), level 3 classification.







Soldering Reflow Profile

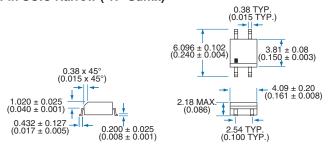
For proper assembly, the component must be processed in accordance with the current revision of IPC/JEDEC standard J-STD-020. Failure to follow the recommended guidelines may cause permanent damage to the device resulting in impaired performance and/or a reduced lifetime expectancy.

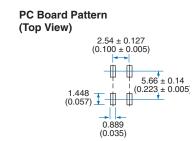
Washing

Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.

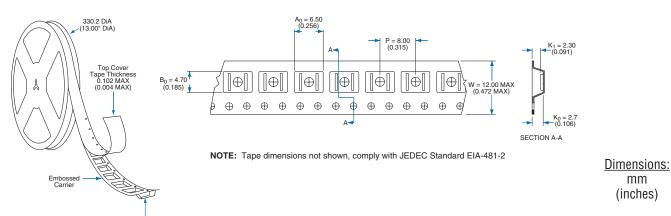
MECHANICAL DIMENSIONS

4-Pin SOIC Narrow ("N" Suffix)





Tape and Reel Packaging for 4-pin SOP package



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